### Symbol | Hit Count | Tool Size | Plated | Hole Type
--- | --- | --- | --- | ---
| | 15 | 15mil (0.381mm) | PTH | Round |
| | 51 | 30mil (0.762mm) | PTH | Round |
| | 6 | 63mil (1.6mm) | PTH | Round |
| | 4 | 98.425mil (2.5mm) | PTH | Round |
| | 4 | 125.984mil (3.2mm) | PTH | Round |

#### 80 Total

Drill Table
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